

## HW 8

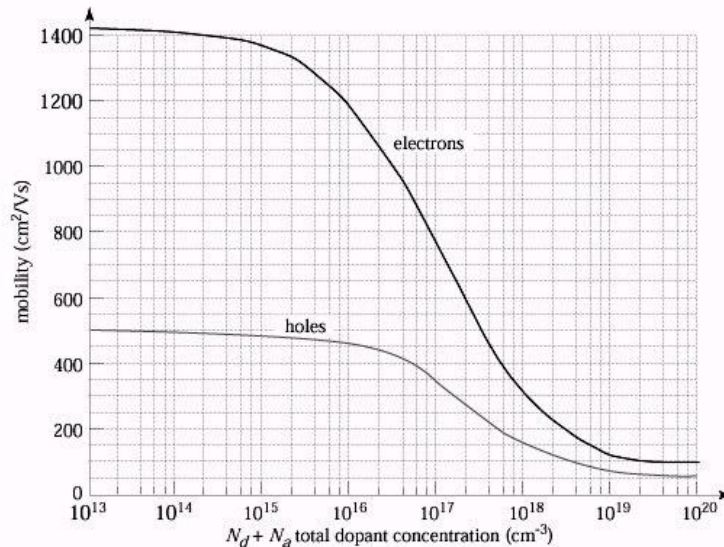
due Friday 4/20/2012

EE40

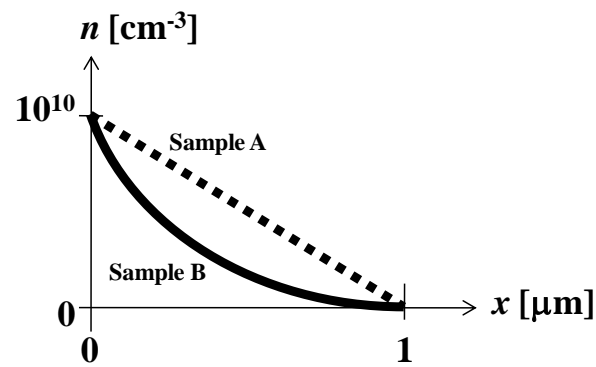
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Spring 2012

1. The first transistors were fabricated using germanium (Ge) as the semiconductor material. Ge has a much smaller bandgap energy ( $E_{g,Ge} = 0.66$  eV) than silicon ( $E_{g,Si} = 1.12$  eV). Would you expect the intrinsic carrier concentration in a Ge sample to be larger or smaller than that in a Si sample maintained at the same temperature? Explain your answer qualitatively, *i.e.* without resorting to any equations.
2. Consider a Si sample maintained under thermal equilibrium conditions at  $T = 300K$ , doped with arsenic at a concentration of  $3 \times 10^{16} \text{ cm}^{-3}$ .
  - a) Is this material n-type or p-type? What are the majority and minority carrier concentrations?
  - b) Suppose this sample is additionally doped with phosphorus at a concentration of  $10^{16} \text{ cm}^{-3}$ . How will the carrier concentrations change? Explain qualitatively why this is the case.
3. The electron and hole mobilities in Si at 300K are plotted as a function of **total** dopant concentration below. Consider a silicon sample maintained at 300K, doped with arsenic at a concentration of  $10^{17} \text{ cm}^{-3}$ .
  - a) If an electric field equal to  $0.2V/\mu\text{m}$  is applied, what are the drift velocities of the electrons and holes?
  - b) Calculate the resistivity of this sample.
  - c) How will the resistivity of this sample change if it were to be additionally doped with boron to a concentration of  $2 \times 10^{17} \text{ cm}^{-3}$ ?

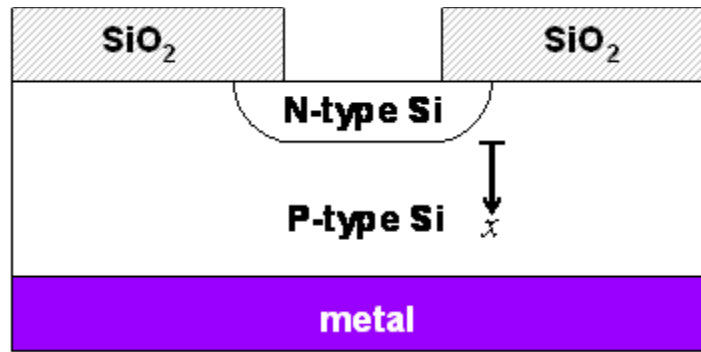


4. Suppose electrons are continuously injected (at  $x = 0$ ) into two p-type silicon samples maintained at 300K (each with  $N_A = 10^{17} \text{ cm}^{-3}$ ), resulting in the following electron concentration profiles:



- Indicate the direction (+x or -x) of electron diffusion and the direction of electron current flow.
- In which sample is the electron injection rate larger? Explain briefly.
- Calculate the diffusion current density (in units of A/cm<sup>2</sup>) in Sample A.

5. Suppose a PN junction is formed by locally introducing arsenic into the surface region of a silicon sample that is uniformly doped with  $3 \times 10^{17} \text{ cm}^{-3}$  boron:



The arsenic concentration is uniformly  $3 \times 10^{18} \text{ cm}^{-3}$  in the N-type region. You may use the depletion approximation.

- Calculate the built-in potential,  $V_0$ .
- Calculate the width of the depletion region,  $W_{\text{dep}}$ .
- Calculate the junction capacitance,  $C_j$ , in units of F/cm<sup>2</sup>.